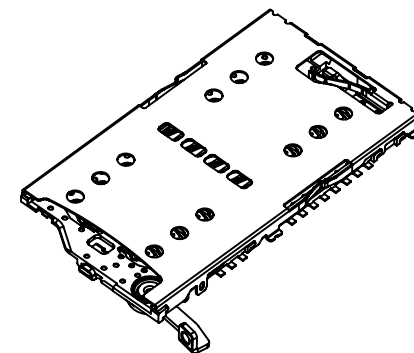
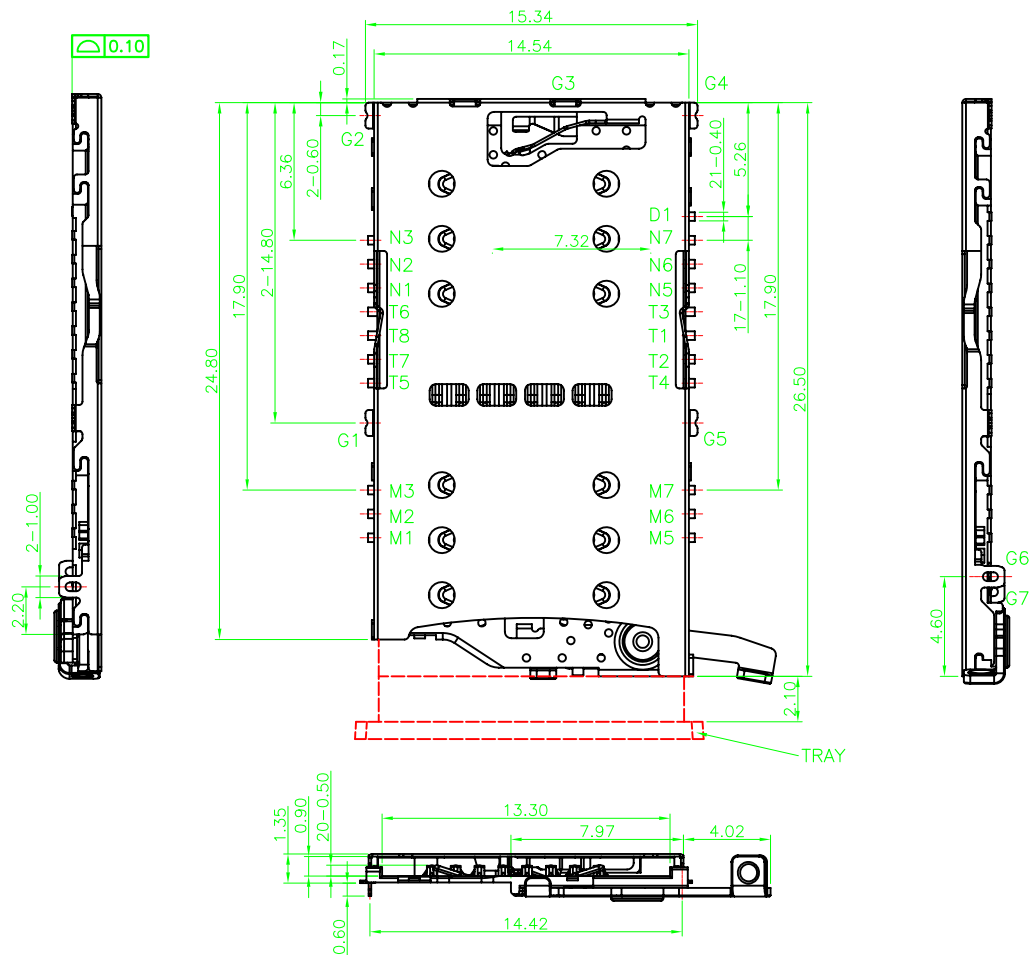




NOTES:

1. MATERIAL:

- 1.1 Housing: High Temperature Thermoplastic
UL94V-0; Color Black.
- 1.2 Contact: Copper Alloy, T=0.10mm.
- 1.3 Shell: Stainless Steel, T=0.12mm.
- 1.4 Crank: Stainless Steel, T=0.40mm

2. FINISH:

- 2.1 Contact: Plated Gold Over all
Underplated Nickel Over all
- 2.2 Shell: Plated Gold on the Solder Tails,
Underplated Nickel Over all

3. SPECIALITY:

- 3.1 Rated current: 0.5A
- 3.2 Rated voltage: 30V
- 3.3 Contact Resistance: 100mΩ MAX
- 3.4 Insulation Resistance: 100MΩ MIN
- 3.5 Dielectric withstanding voltage: 100V AC.
- 3.6 Solder ability: 245±5°C, 5±0.5s.
- 3.7 Durability: 1000 Cycles Min.
- 3.8 Operating condition: Temperature: -30°C~+80°C
Humidity: 80% R.H MAX

RoHS Compliant

TOLERANCES ARE

MORETHANALL
PCB CONNECTORS
Cable ASSEMBLIES

煜倫股份有限公司

www.morethanall.com

DRAWING BY CY

CHECKED BY GENIUS

UNIT / mm

SCALE 1 : 1

DATE

SIZE A4

PPOJECTION

X. ± 0.50
.X ± 0.30
.XX ± 0.20
.XXX ±
ANG ±

照片框

ORDER INFORMATION

NNTFE-WM14B-302-LF

SERIES

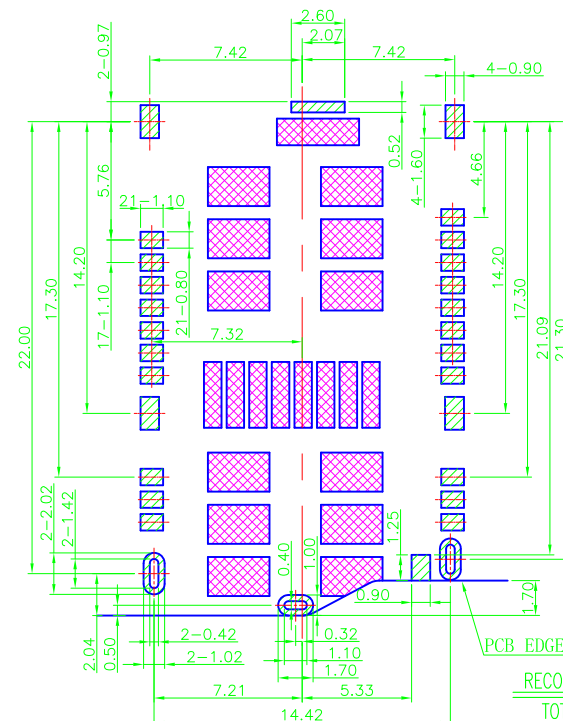
LEADFREE

3 IN 2

OPEN

METAL FOOT 14.42mm
90° SMT

DESCRIPTION: NANO SIM+Micro sd 托盤式



RECOMMENDED PCB LAYOUT

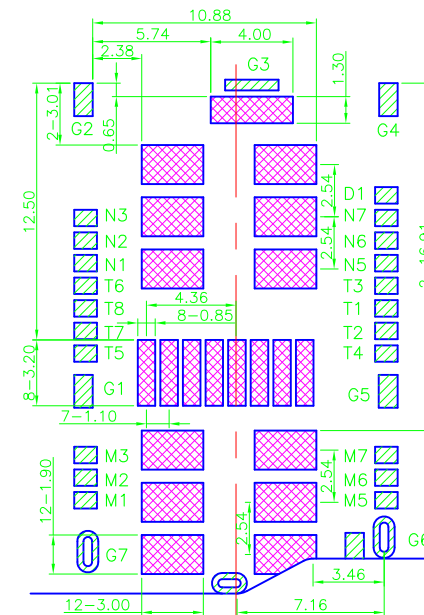
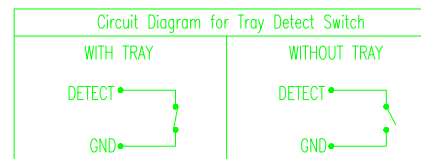
TOLERANCE ± 0.03

THESE AREA SHOULD BE FREE OF ANY CONDUCTIVE TRACES

SMT SOLDER AREA

SIM CARD PIN NO.	DESCRIPTION	T-CARD PIN NO.	DESCRIPTION
N1/M1	VCC	T1	DAT2
N2/M2	RST	T2	CD/DAT3
N3/M3	CLK	T3	CMD
N5/M5	GND	T4	VDD
N6/M6	VPP	T5	CLK
N7/M7	I/O	T6	VSS
D1	DETECT	T7	DAT0
		T8	DAT1

G1-G7 GND



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RoHS Compliant

DRAWING BY CY

CHECKED BY GENIUS

UNIT / mm SCALE 1 : 1

DATE

SIZE A4

TOLERANCES ARE

X. ± 0.50

.X ± 0.30

.XX ± 0.20

.XXX $\pm$

ANG $\pm$

PPOJECTION

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